PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

Docket No: Q80899

Takashi UDAGAWA

Appln. No.: 10/594,683

Group Art Unit: 2826

Confirmation No.: 2074

Examiner: Kevin V. QUINTO

Filed: September 28, 2006

For:

COMPOUND SEMICONDUCTOR DEVICE, PRODUCTION METHOD OF

COMPOUND SEMICONDUCTOR DEVICE AND DIODE

REQUEST FOR CORRECTED OFFICIAL FILING RECEIPT

ATTN: Office of Initial Patent Examination

Filing Receipt Correction Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

We enclose a copy of the Official Filing Receipt for the above-identified application and request the following correction:

Assignment For Published Patent Application

SHOWA DENKO K.K., Tokyo, JAPAN

Verification for the requested correction is indicated on the Assignment filed September 28, 2006.

Respectfully submitted,

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WASHINGTON OFFICE

23373

CUSTOMER NUMBER

Date: June 25, 2009

Abraham J. Rosner

Registration No. 33,276



United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

APPLICATION	FILING or	GRP ART				
NUMBER	371(c) DATE	UNIT	FIL FEE REC'D	ATTY.DOCKET.NO	TOT CLAIMS	IND CLAIMS
10/594,683	09/28/2006	2826	900	Q80899	9	3

23373 SUGHRUE MION, PLLC 2100 PENNSYLVANIA AVENUE, N.W. SUITE 800 WASHINGTON, DC 20037

CONFIRMATION NO. 2074 CORRECTED FILING RECEIPT



Date Mailed: 05/01/2009

Receipt is acknowledged of this non-provisional patent application. The application will be taken up for examination in due course. Applicant will be notified as to the results of the examination. Any correspondence concerning the application must include the following identification information: the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please submit a written request for a Filing Receipt Correction. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections

Applicant(s)

Assignment for Published Patent Application
Takashi Udagawa, Chichibu-shi, JAPAN; SHOWA DENKO K. K., Tokyo JAPAN

Power of Attorney: The patent practitioners associated with Customer Number 23373

Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP05/06534 03/28/2005 and claims benefit of 60/560,268 04/08/2004

Foreign Applications

JAPAN 2004-098876 03/30/2004

If Required, Foreign Filing License Granted: 05/22/2007

The country code and number of your priority application, to be used for filing abroad under the Paris Convention, is US 10/594,683

Projected Publication Date: Not Applicable

Non-Publication Request: No

Early Publication Request: No

110504711S (15户20935 For Non-U.S. Clients (15(議)/

ASSIGNMENT

Whereas, I/we Takashi UDAGAWA of c/o SHOWA DENKO K.K., 1505, Shimokagemori, Chichibu-shi, Saitama-ken, Japan

hereinafter called assignor(s), have invented certain improvements in COMPOUND SEMICONDUCTOR DEVICE, PRODUCTION METHOD OF COMPOUND SEMICONDUCTOR DEVICE AND DIODE and executed an application for Letters Patent of the United States of America therefor on

August 21, 2006

; and

Whereas,

SHOWA DENKO K.K. of 13-9, Shibadaimon 1-chome, Minato-ku, Tokyo, Japan

(assignee), desires to acquire the entire right, title and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

I/We, the above named assignor(s), hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including the right to claim priority under 35 U.S.C. § 119, and I/we request the Director – U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States application when called upon to do so by the assignee.

I/We hereby authorize and request my/our attorneys SUGHRUE MION, PLLC of 2100 Pennsylvania Avenue, N.W., Washington, D.C. 20037-3213 to insert here in parentheses (Application number______, filed______) the filing date and application number of said application when known.

Date: August 21, 2006	si Jakashi Udagawa Takashi UDAGAWA
Jale, magaz v 11, man	Takashi UDAGAWA
Date:	s/
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